

P-Channel Enhancement Mode MOSFET
◆ DESCRIPTION

The MT3413 is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology.

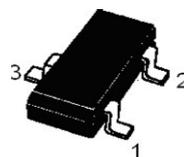
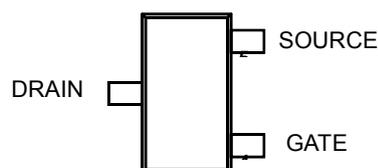
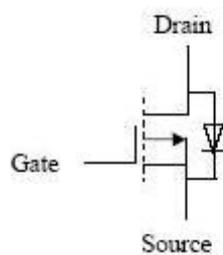
This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other batter powered circuits where high-side switching, and low in-line power loss are needed in a very small outline surface mount package

◆ FEATURES

- -20V/-3.4A, $R_{DS(ON)} = 95 \text{ m}\Omega @ V_{GS} = -4.5\text{V}$
- -20V/-2.6A, $R_{DS(ON)} = 120 \text{ m}\Omega @ V_{GS} = -2.5\text{V}$
- -20V/-1A, $R_{DS(ON)} = 145 \text{ m}\Omega @ V_{GS} = -1.8\text{V}$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability

◆ APPLICATIONS

- POWER Management in Note
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC

◆ PIN CONFIGURATION


◆ ABSOLUTE MAXIMUM RATINGS

 (T_A=25°C Unless Otherwise Noted)

Parameter	Symbol	Maximum	Unit
Drain-Source Voltage	V _{DS}	-20	V
Gate-Source Voltage	V _{GS}	± 12	V
Continuous Drain Current	I _D	T _A = 25°C	-3.4
		T _A = 70°C	-2.4
Pulsed Drain Current	I _{DM}	-15	A
Continuous Source Current (Diode Conduction)	I _S	-2	A
Power Dissipation	P _D	T _A = 25°C	1.4
		T _A = 70°C	0.9
Operating junction temperature range	T _J	150	°C
Storage temperature range	T _{STG}	- 55 to 150	°C

◆ THERMAL RESISTANCE RATINGS

Parameter	Symbol	Maximum	Unit
Junction-to-Ambient	R _{θJA}	100	°C/W

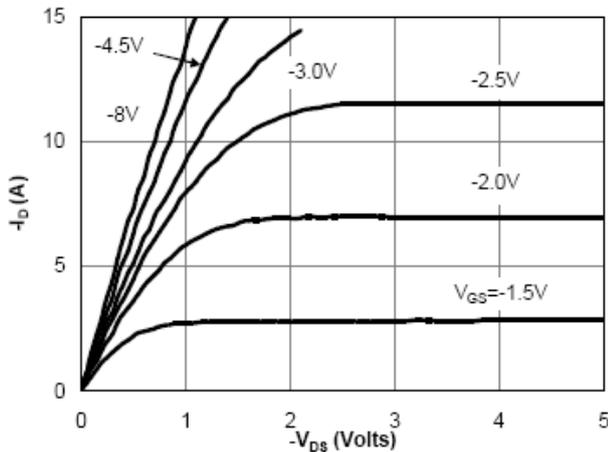
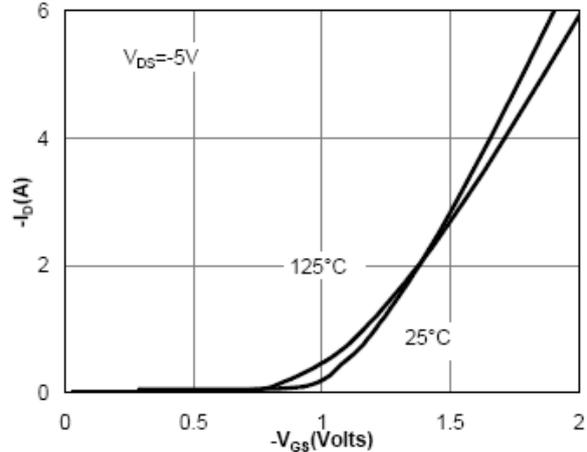
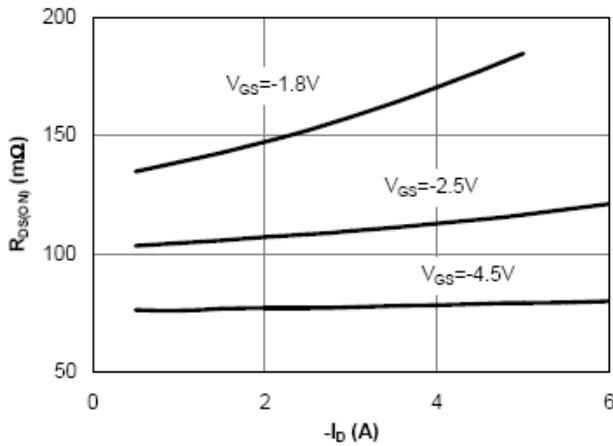
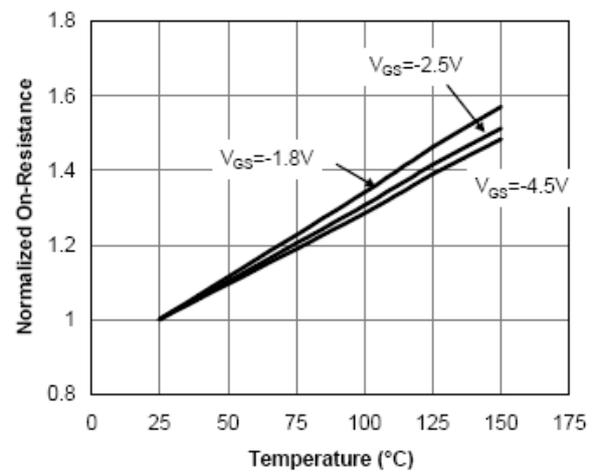
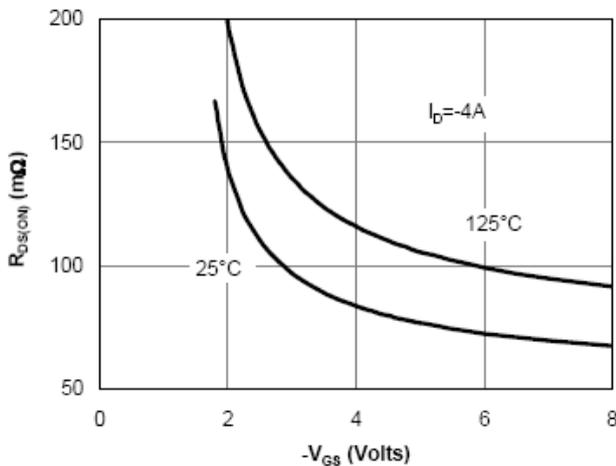
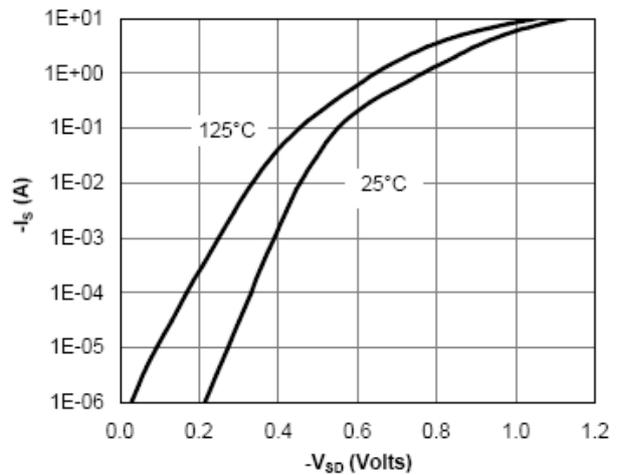
◆ ORDERING INFORMATION

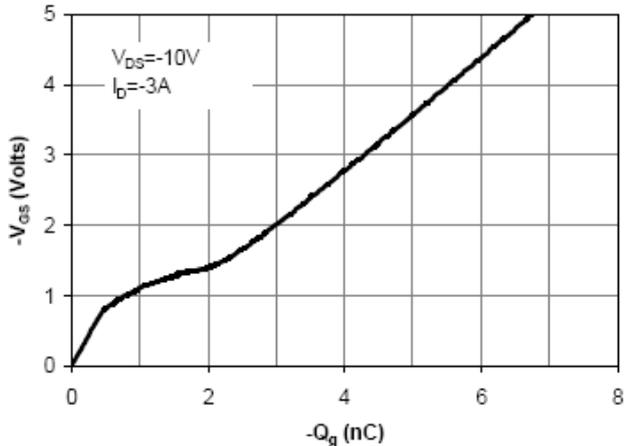
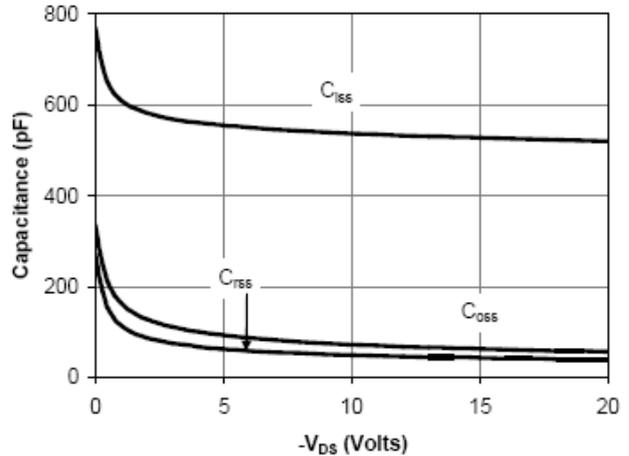
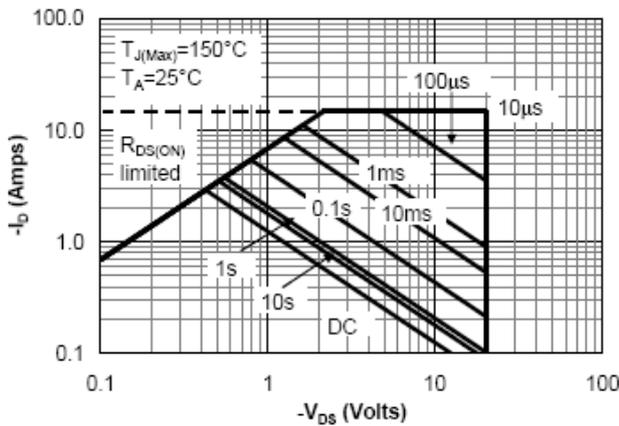
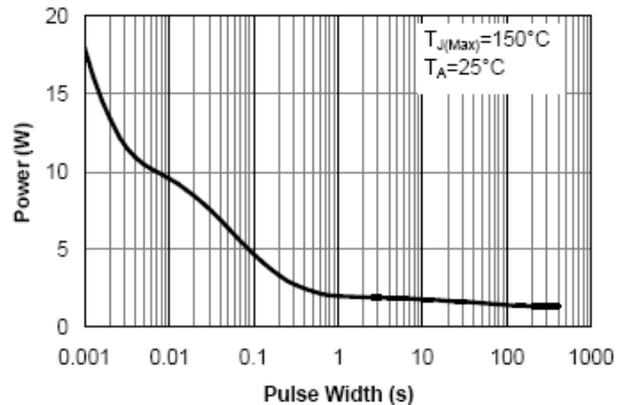
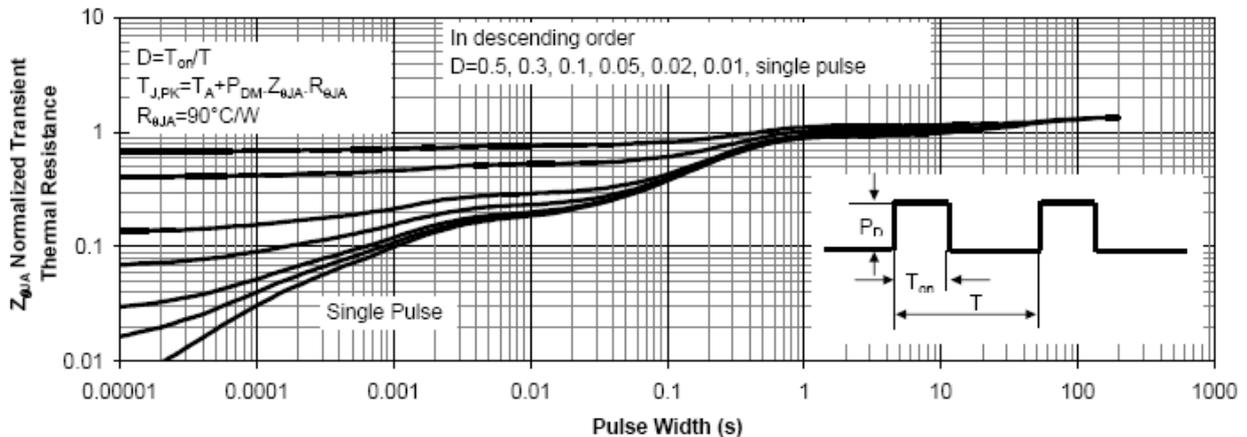
Device	Package	Shipping
MT3413	SOT-23	3000 PCS / Tape & Reel

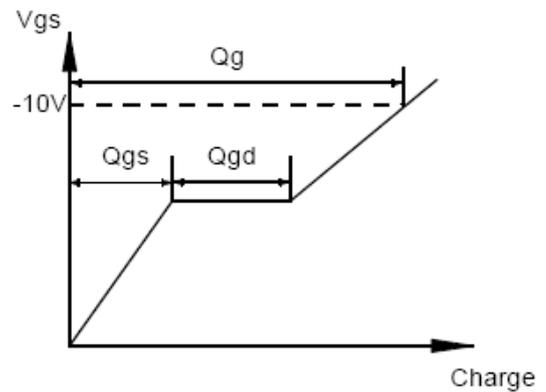
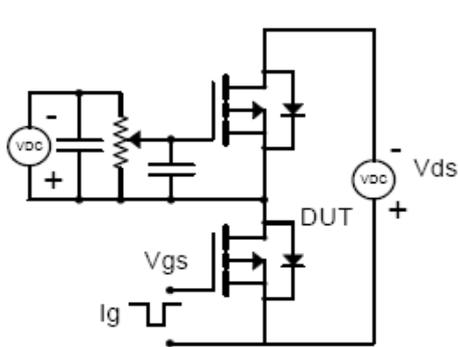
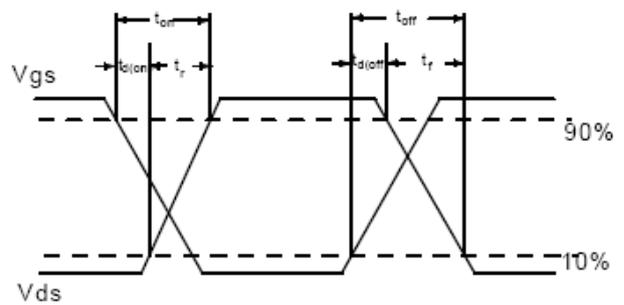
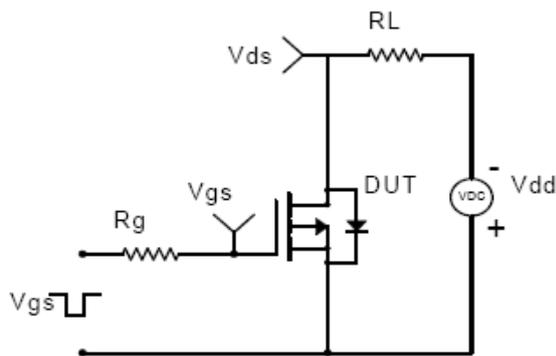
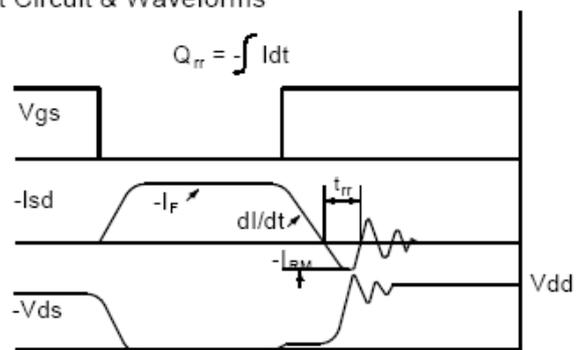
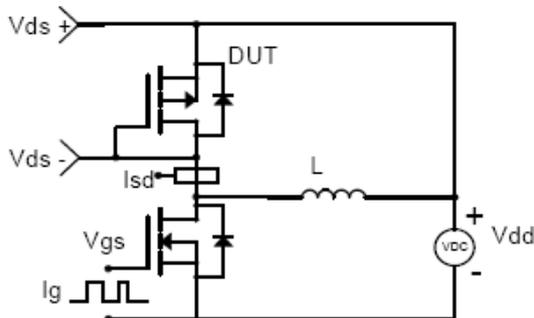
P-Channel Enhancement Mode MOSFET
◆ ELECTRICAL CHARACTERISTICS

 (T_A=25°C Unless Otherwise Noted)

Static Parameters						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	-20	-	-	V
Gate Threshold Voltage	V _{GS(th)}	V _{GS} = V _{DS} , I _D = 250μA	0.4	-	0.8	V
Gate Leakage Current	I _{GSS}	V _{DS} = 0V, V _{GS} = ± 12 V	-	-	±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -20V, V _{GS} = 0 V	-	-	1	μA
		V _{DS} = -20V, V _{GS} = 0V, T _J = 55 °C	-	-	5	
Forward Trans conductance	g _{fs}	V _{DS} = -5V, I _D = -3.4A	-	7	-	S
On-State Drain Current	I _{D(ON)}	V _{DS} ≤ -5V, V _{GS} = -4.5V	-15	-	-	A
Drain-Source On Resistance	R _{DS(ON)}	V _{GS} = -4.5V, I _D = -3.4A	-	80	95	mΩ
		V _{GS} = -2.5V, I _D = -2.6A	-	105	120	
		V _{GS} = -1.8V, I _D = -1.0A	-	130	145	
Diode Forward Voltage	V _{SD}	I _S = -1.0A, V _{GS} = 0V	-	0.75	-1.0	V
Dynamic Parameters						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Input Cap.	C _{iss}	V _{DS} = -10V, V _{GS} = 0V, F = 1MHz	-	540	-	pF
Output Cap.	C _{oss}		-	72	-	
Reverse Transfer Cap.	C _{rss}		-	49	-	
Total Gate Charge	Q _g	V _{DS} = -10V, V _{GS} = -4.5V, I _D = -1.0A	-	6.1	-	nC
Gate-Source Charge	Q _{gs}		-	0.6	-	
Gate-Drain Charge	Q _{gd}		-	1.6	-	
Turn-On Time	T _{D(ON)}	V _{DS} = -10V, R _L = 3.3Ω, V _{GEN} = -4.5V, R _G = 3Ω	-	10	-	nS
	t _r		-	12	-	
Turn-Off Time	T _{D(OFF)}		-	44	-	
	t _f		-	22	60	

P-Channel Enhancement Mode MOSFET
◆ TYPICAL CHARACTERISTICS

Fig 1: On-Region Characteristics

Figure 2: Transfer Characteristics

Figure 3: On-Resistance vs. Drain Current and Gate Voltage

Figure 4: On-Resistance vs. Junction Temperature

Figure 5: On-Resistance vs. Gate-Source Voltage

Figure 6: Body-Diode Characteristics

◆ TYPICAL CHARACTERISTICS

Figure 7: Gate-Charge Characteristics

Figure 8: Capacitance Characteristics

Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

Figure 11: Normalized Maximum Transient Thermal Impedance

◆ TYPICAL CHARACTERISTICS
Gate Charge Test Circuit & Waveform

Resistive Switching Test Circuit & Waveforms

Diode Recovery Test Circuit & Waveforms


◆ PHYSICAL DIMENSIONS
3-Pin surface Mount SOT-23(S)
